

TOSHIBA PHOTOCOUPLER GaAlAs IRED & PHOTO-IC

TLP250

TRANSISTOR INVERTER
INVERTER FOR AIR CONDITIONOR
IGBT GATE DRIVE
POWER MOS FET GATE DRIVE

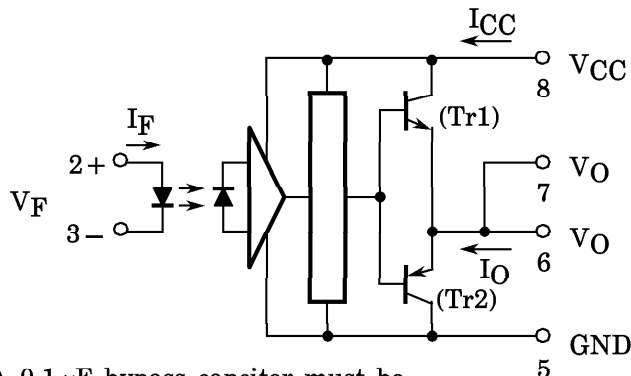
The TOSHIBA TLP250 consists of a GaAlAs light emitting diode and a integrated photodetector.
This unit is 8-lead DIP package.
TLP250 is suitable for gate driving circuit of IGBT or power MOS FET.

- Input Threshold Current : $I_F = 5\text{mA}$ (Max.)
- Supply Current (I_{CC}) : 11mA (Max.)
- Supply Voltage (V_{CC}) : $10\text{-}35\text{V}$
- Output Current (I_O) : $\pm 1.5\text{A}$ (Max.)
- Switching Time (t_{pLH}/t_{pHL}) : $1.5\mu\text{s}$ (Max.)
- Isolation Voltage : $2500V_{rms}$ (Min.)
- UL Recognized : UL1577, File No.E67349
- Option (D4) type
VDE Approved : DIN VDE0884 / 06.92, Certificate No.76823
Maximum Operating Insulation Voltage : $630V_{PK}$
Highest Permissible Over Voltage : $4000V_{PK}$

(Note) When a VDE0884 approved type is needed,
please designate the "Option (D4)"

- Creepage Distance : 6.4mm (Min.)
Clearance : 6.4mm (Min.)

SCHMATIC

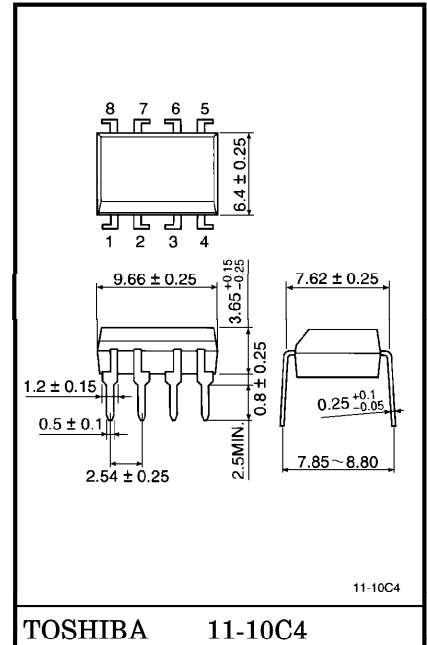


A $0.1\mu\text{F}$ bypass capacitor must be connected between pin 8 and 5 (See Note 5).

TRUTH TABLE

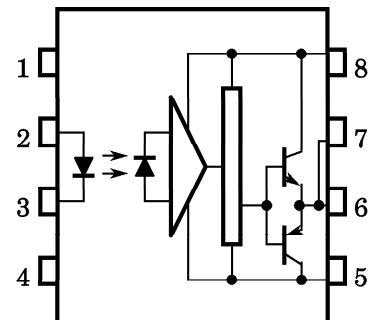
		Tr1	Tr2
Input LED	ON	ON	OFF
	OFF	OFF	ON

Unit in mm



Weight : 0.54g

PIN CONFIGURATION (TOP VIEW)



- 1 : N.C.
- 2 : ANODE
- 3 : CATHODE
- 4 : N.C.
- 5 : GND
- 6 : V_O (OUTPUT)
- 7 : V_O
- 8 : V_{CC}

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC			SYMBOL	RATING	UNIT
LED	Forward Current		I _F	20	mA
	Forward Current Derating (Ta≥ 70°C)		ΔI _F / ΔTa	−0.36	mA / °C
	Peak Transient Forward Curent (Note 1)		I _{FPT}	1	A
	Reverse Voltage		V _R	5	V
	Junction Temperature		T _j	125	°C
DETECTOR	“H” Peak Output Current (P _W ≤ 2.5μs, f≤ 15kHz)(Note 2)		I _{OPH}	−1.5	A
	“L” Peak Output Current (P _W ≤ 2.5μs, f≤ 15kHz) (Note 2)		I _{OPL}	+1.5	A
	Output Voltage	(Ta≤ 70°C)	V _O	35	V
		(Ta= 85°C)		24	
	Supply Voltage	(Ta≤ 70°C)	V _{CC}	35	V
		(Ta= 85°C)		24	
	Output Voltage Derating (Ta≥ 70°C)		ΔV _O / ΔTa	−0.73	V / °C
	Supply Voltage Derating (Ta≥ 70°C)		ΔV _{CC} / ΔTa	−0.73	V / °C
	Junction Temperature		T _j	125	°C
Operating Frequency (Note 3)			f	25	kHz
Operating Temperature Range			T _{opr}	−20~85	°C
Storage Temperature Range			T _{stg}	−55~125	°C
Lead Soldering Temperature (10s)			T _{sol}	260	°C
Isolation Voltage (AC, 1min., R.H.≤ 60%) (Note 4)			BV _S	2500	Vrms

(Note 1) Pulse width $P_W \leq 1 \mu s$, 300pps

(Note 2) Exponential Waveform

(Note 3) Exponential Waveform, $I_{OPH} \leq -1.0 \text{ A}$ ($\leq 2.5 \mu s$), $I_{OPL} \leq +1.0 \text{ A}$ ($\leq 2.5 \mu s$)

(Note 4) Device considered a two terminal device : pins 1,2,3 and 4 shorted together, and pins 5, 6, 7 and 8 shorted together.

(Note 5) A ceramic capacitor (0.1 μF) should be connected from pin 8 to pin 5 to stabilize the operation of the high gain linear amplifier. Failure to provide the bypassing may impair the switching property. The total lead length between capacitor and coupler should not exceed 1cm.

RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.		UNIT
Input Current, ON	$I_F (ON)$	7	8	10		mA
Input Voltage, OFF	$V_F (OFF)$	0	—	0.8		V
Supply Voltage	V_{CC}	15	—	30	20	V
Peak Output Current	I_{OPH} / I_{OPL}	—	—	± 0.5		A
Operating Temperature	T_{opr}	−20	25	70	85	°C

ELECTRICAL CHARACTERISTICS (Ta = -20~70°C, Unless otherwise specified)

CHARACTERISTIC		SYMBOL	TEST CIRCUIT	TEST CONDITION	MIN.	TYP.*	MAX.	UNIT
Input Forward Voltage		V _F	—	I _F = 10mA, Ta = 25°C		1.6	1.8	V
Temperature Coefficient of Forward Voltage		ΔV _F / ΔTa	—	I _F = 10mA	—	-2.0	—	mV / °C
Input Reverse Current		I _R	—	V _R = 5V, Ta = 25°C		—	10	μA
Input Capacitance		C _T	—	V = 0, f = 1MHz, Ta = 25°C	—	45	250	pF
Output Current	“H” Level	I _{OPH}	3	V _{CC} = 30V (*1) I _F = 10mA V ₈₋₆ = 4V I _F = 0 V ₆₋₅ = 2.5V	-0.5	-1.5	—	A
	“L” Level	I _{OPL}	2		0.5	2	—	
Output Voltage	“H” Level	V _{OH}	4	V _{CC1} = +15V, V _{EE1} = -15V R _L = 200Ω, I _F = 5mA	11	12.8	—	V
	“L” Level	V _{OL}	5	V _{CC1} = +15V, V _{EE1} = -15V R _L = 200Ω, V _F = 0.8V	—	-14.2	-12.5	
Supply Current	“H” Level	I _{CCH}	—	V _{CC} = 30V, I _F = 10mA Ta = 25°C	—	7	—	mA
				V _{CC} = 30V, I _F = 10mA	—	—	11	
	“L” Level	I _{CCL}	—	V _{CC} = 30V, I _F = 0mA Ta = 25°C	—	7.5	—	
				V _{CC} = 30V, I _F = 0mA	—	—	11	
Threshold Input Current	“Output L→H”	I _{FLH}	—	V _{CC1} = +15V, V _{EE1} = -15V R _L = 200Ω, V _O > 0V	—	1.2	5	mA
Threshold Input Voltage	“Output H→L”	V _{FHL}	—	V _{CC1} = +15V, V _{EE1} = -15V R _L = 200Ω, V _O < 0V	0.8	—	—	V
Supply Voltage		V _{CC}	—		10	—	35	V
Capacitance (Input-Output)		C _S	—	V _S = 0, f = 1MHz Ta = 25°C	—	1.0	2.0	pF
Resistance (Input-Output)		R _S	—	V _S = 500V, Ta = 25°C R.H. ≤ 60%	1×10 ¹²	10 ¹⁴	—	Ω

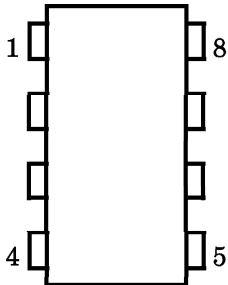
* All typical values are at Ta = 25°C (*1) : Duration of I_O time ≤ 50μs

SWITCHING CHARACTERISTICS (Ta = -20~70°C, Unless otherwise specified)

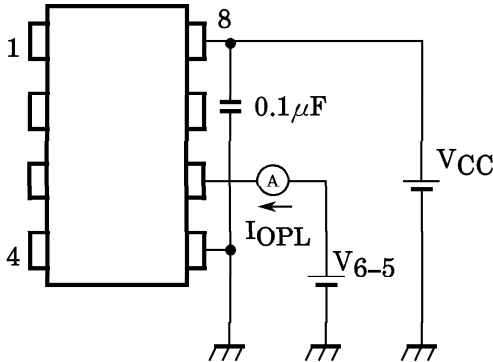
CHARACTERISTIC		SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN.	TYP.*	MAX.	UNIT
Propagation Delay Time	L→H	t _{pLH}	6	I _F = 8mA V _{CC1} = +15V, V _{EE1} = -15V R _L = 200Ω	—	0.15	0.5	μs
	H→L	t _{pHL}			—	0.15	0.5	
Output Rise Time		t _r			—	—	—	
Output Fall Time		t _f			—	—	—	
Common Mode Transient Immunity at High Level Output		C _{MH}	7	V _{CM} = 600V, I _F = 8mA V _{CC} = 30V, Ta = 25°C	-5000	—	—	V / μs
Common Mode Transient Immunity at Low Level Output		C _M L	7	V _{CM} = 600V, I _F = 0mA V _{CC} = 30V, Ta = 25°C	5000	—	—	V / μs

* All typical values are at Ta = 25°C

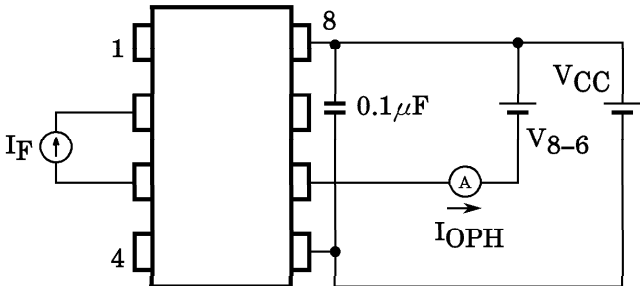
TEST CIRCUIT 1 :



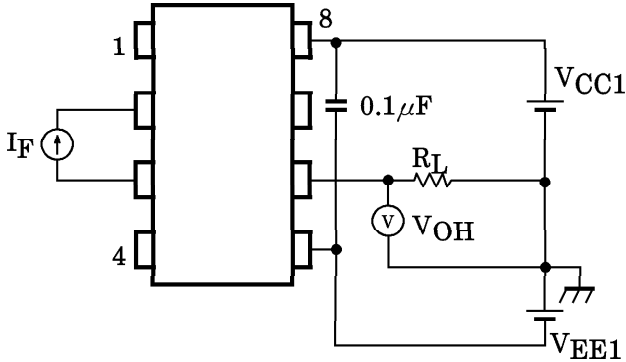
TEST CIRCUIT 2 : IOPL



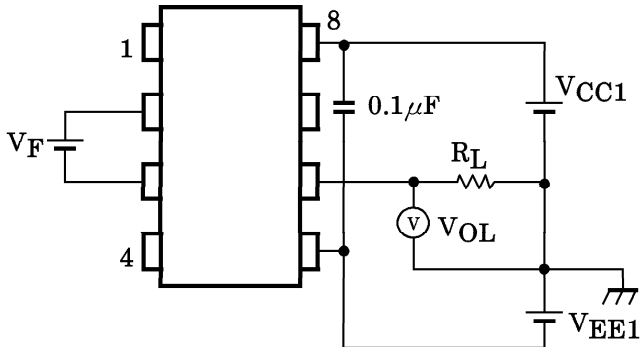
TEST CIRCUIT 3 : IOPH



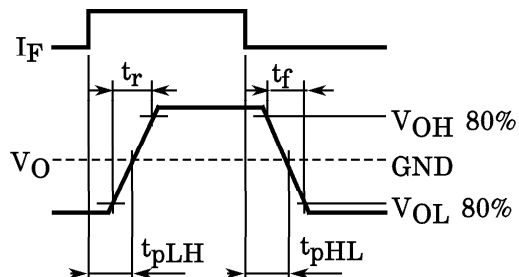
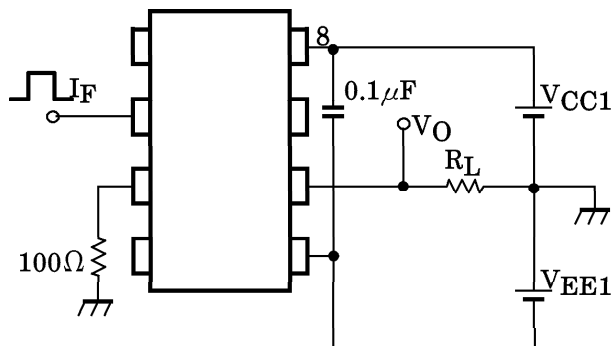
TEST CIRCUIT 4 : VOH



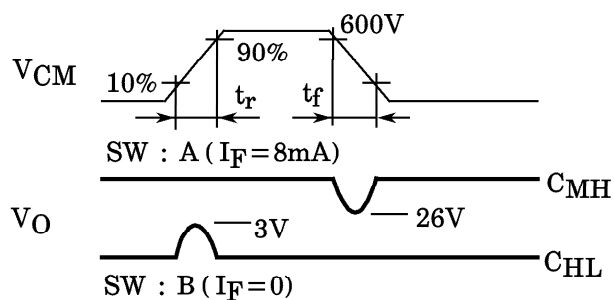
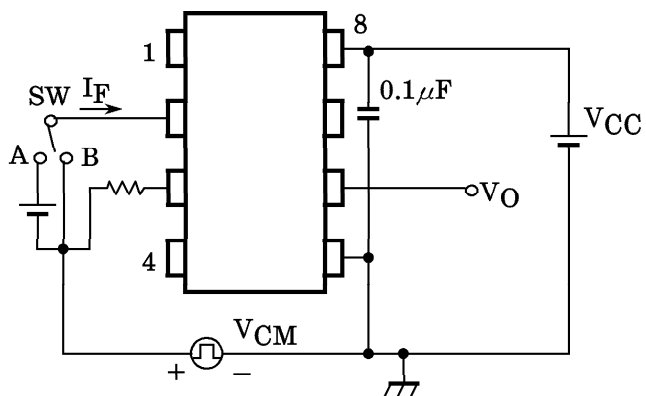
TEST CIRCUIT 5 : VOL



TEST CIRCUIT 6 : t_{pLH} , t_{pHL} , t_r , t_f



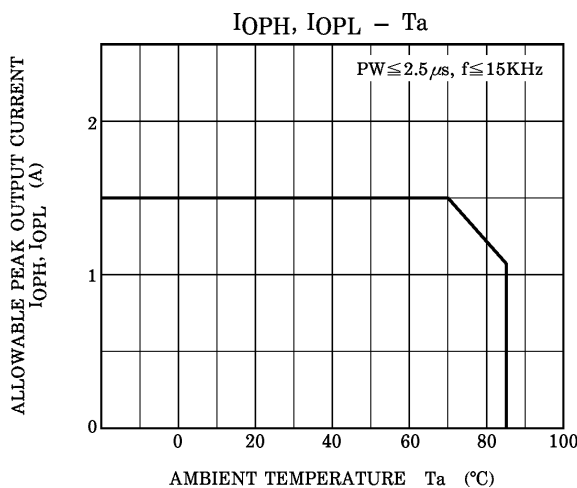
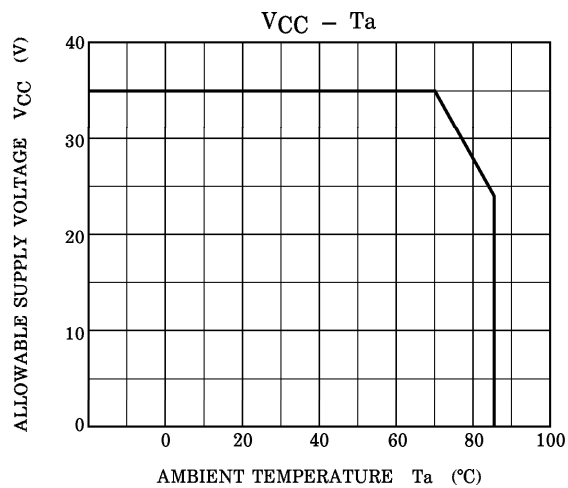
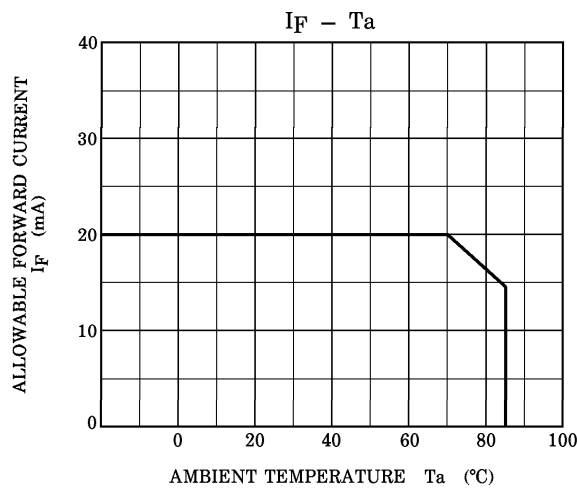
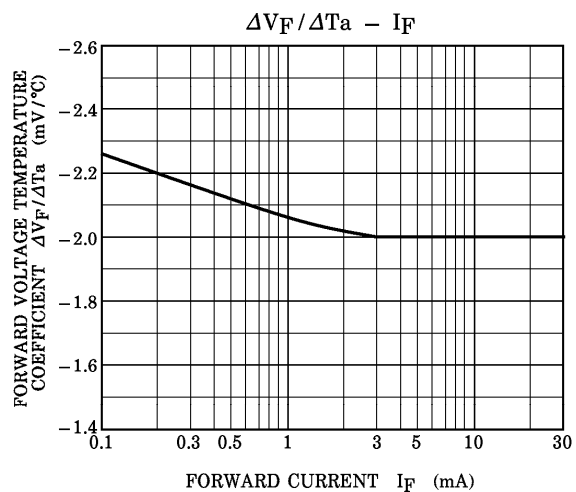
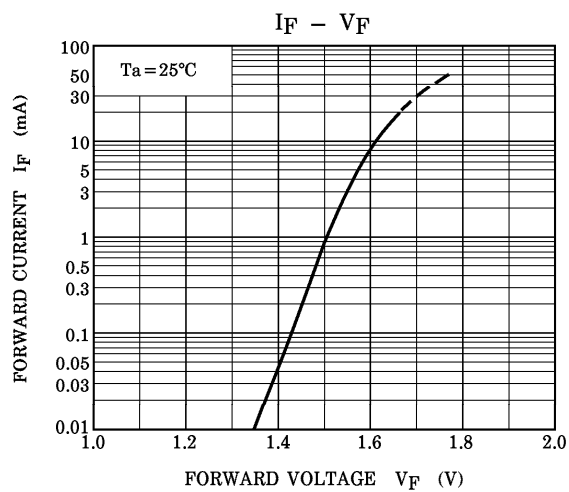
TEST CIRCUIT 7 : C_{MH} , C_{ML}



$$C_{ML} = \frac{480(V)}{t_f(\mu s)}$$

$$C_{MH} = \frac{480(V)}{t_r(\mu s)}$$

C_{ML} (C_{MH}) is the maximum rate of rise (fall) of the common mode voltage that can be sustained with the output voltage in the low (high) state.



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